BLC6G20-75; BLC6G20LS-75

UHF power LDMOS transistor

Rev. 01 — 30 January 2006

Objective data sheet



1.1 General description

 $75~\mathrm{W}$ LDMOS power transistor for base station applications at frequencies from 1800 MHz to 2000 MHz.

Table 1: Typical performance

RF performance at T_{case} = 25 °C in a common source class-AB production test circuit.

Mode of operation	f	V _{DS}	P _{L(AV)}	Gp	η _D	ACPR ₄₀₀	ACPR ₆₀₀	EVM _{rms}
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)	(dBc)	(%)
CW	1930 to 1990	28	63	19	52	-	-	-
GSM EDGE	1930 to 1990	28	29.5	19	38.5	-62.5	-72	1.5

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features

- Typical GSM EDGE performance at frequencies of 1930 MHz and 1990 MHz, a supply voltage of 28 V and an I_{Dq} of 550 mA:
 - ◆ Output power = 29.5 W (AV)
 - ◆ Gain = 19 dB
 - Efficiency = 38.5 %
 - ◆ $ACPR_{400} = -62.5 dBc$
 - ◆ ACPR₆₀₀ = -72 dBc
 - ◆ EVM_{rms} = 1.5 %
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (1800 MHz to 2000 MHz)
- Internally matched for ease of use



1.3 Applications

■ RF power amplifiers for GSM, GSM EDGE, W-CDMA and CDMA base stations and multi carrier applications in the 1800 MHz to 2000 MHz frequency range.

2. Pinning information

Table 2: Pinning

Pin	Description	Simplified outline	Symbol
	0-75 (SOT895-1)		
1	drain		
2	gate		1
3	source		2 — — 3 sym112
BLC6G2	0LS-75 (SOT896-1)		
1	drain		
2	gate	1 1	1 <u> </u>
3	source	[1] 2	2 — 3 3 sym112

^[1] Connected to flange

3. Ordering information

Table 3: Ordering information

Type number	Package	Package		
	Name	Description	Version	
BLC6G20-75	-	plastic flanged cavity package; 2 mounting slots; 2 leads	SOT895-1	
BLC6G20LS-75	-	plastic earless flanged cavity package; 2 leads	SOT896-1	

4. Limiting values

Table 4: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
I _D	drain current		-	<tbd></tbd>	Α
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	225	°C

5. Thermal characteristics

Table 5: Thermal characteristics

Symbol	Parameter	Conditions	Туре	Min	Тур	Max	Unit
R _{th(j-case)}	thermal resistance	$T_{case} = 80 ^{\circ}\text{C};$ $P_L = 75 \text{W}$	BLC6G20-75	<tbd></tbd>	<tbd></tbd>	<tbd></tbd>	K/W
	from junction to case		BLC6G20LS-75	<tbd></tbd>	<tbd></tbd>	<tbd></tbd>	K/W

6. Characteristics

Table 6: Characteristics

 $T_i = 25 \,^{\circ}C$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.5 \text{ mA}$	65	-	-	V
V _{GS(th)}	gate-source threshold voltage	$V_{DS} = 10 \text{ V}; I_{D} = 100 \text{ mA}$	<tbd></tbd>	2	<tbd></tbd>	V
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 28 \text{ V}; I_{D} = 550 \text{ mA}$	<tbd></tbd>	<tbd></tbd>	<tbd></tbd>	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V}$	-	-	3	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	15.5	18	-	Α
I_{GSS}	gate leakage current	$V_{GS} = 13 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	300	nΑ
9 _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 5 \text{ A}$	-	7	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 3.5 \text{ A}$	-	0.15	0.185	Ω
C _{rs}	feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 28 \text{ V};$ f = 1 MHz	-	1.6	-	pF

7. Application information

Table 7: Application information

Mode of operation: GSM EDGE; f = 1930 MHz and 1990 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 550 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$P_{L(AV)}$	average output power		-	29.5	-	W
Gp	power gain	$P_{L(AV)} = 29.5 \text{ W}$	17.5	19	20	dB
IRL	input return loss	$P_{L(AV)} = 29.5 \text{ W}$	-	-10	-7	dB
η_{D}	drain efficiency	$P_{L(AV)} = 29.5 \text{ W}$	36.5	38.5	-	%
ACPR ₄₀₀	adjacent channel power ratio (400 kHz)	$P_{L(AV)} = 29.5 \text{ W}$	-	-62.2	-60	dBc
ACPR ₆₀₀	adjacent channel power ratio (600 kHz)	$P_{L(AV)} = 29.5 \text{ W}$	-	-72	-70	dBc
EVM_{rms}	RMS EDGE signal distortion error	$P_{L(AV)} = 29.5 \text{ W}$	-	1.5	2.3	%
EVM _M	peak EDGE signal distortion error	$P_{L(AV)} = 29.5 \text{ W}$	-	4.8	8	%

7.1 Ruggedness in class-AB operation

The BLC6G20-75 and BLC6G20LS-75 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 28 \text{ V}$; $I_{Dq} = 550 \text{ mA}$; $P_L = 75 \text{ W}$ (CW); f = 1990 MHz.

BLC6G20-75_6G20LS-75_1

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8. Package outline

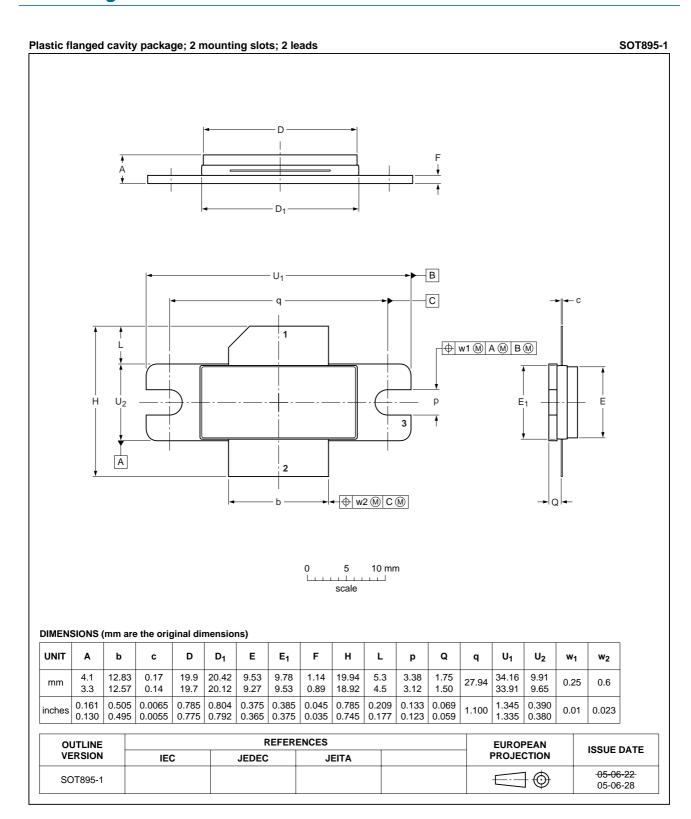


Fig 1. Package outline SOT895-1

BLC6G20-75_6G20LS-75_1

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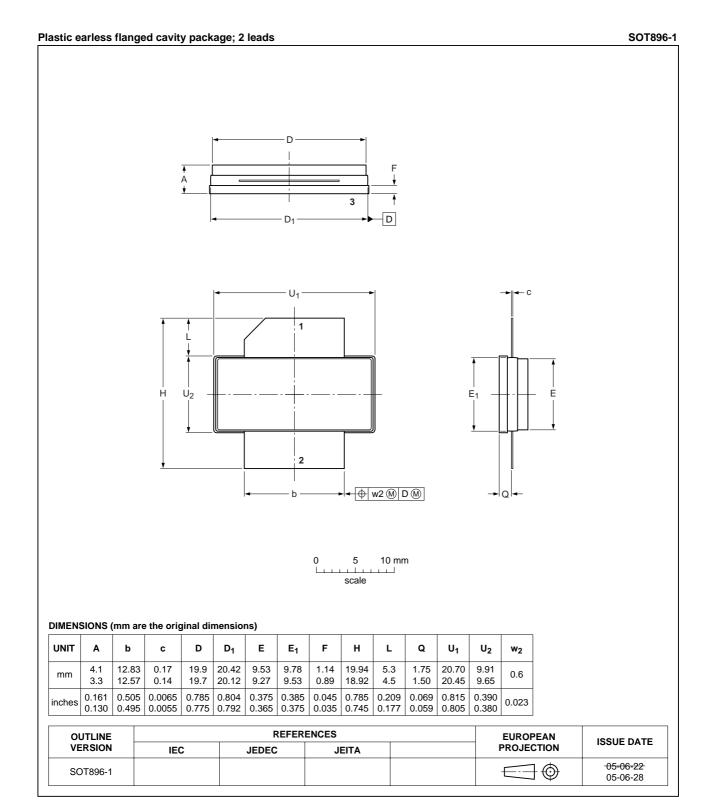


Fig 2. Package outline SOT896-1



9. Abbreviations

Table 8: Abbreviations

Acronym	Description
CDMA	Code Division Multiple Access
CW	Continuous Wave
EDGE	Enhanced Data rates for GSM Evolution
EVM	Error Vector Magnitude
GSM	Global System for Mobile communications
LDMOS	Laterally Diffused Metal Oxide Semiconductor
RF	Radio Frequency
RMS	Root Mean Square
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access



10. Revision history

Table 9: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
BLC6G20-75_6G20L S-75_1	20060130	Objective data sheet	-	-	-



Level	Data sheet status [1]	Product status [2] [3]	Definition
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UHF power LDMOS transistor

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